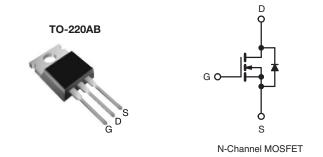


### **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	10	100				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	0.16				
Q <sub>g</sub> (Max.) (nC)	26	26				
Q <sub>gs</sub> (nC)	5.5	5.5				
Q <sub>gd</sub> (nC)	11	11				
Configuration	Sing	Single				



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- 175 °C Operating Temperature
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF530PbF		
Lead (FD)-life	SiHF530-E3		
SnPb	IRF530		
SIFD	SiHF530		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
					UNIT	
Drain-Source Voltage			$V_{DS}$	100	- v	
Gate-Source Voltage			$V_{GS}$	± 20	,	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	I_	14		
	VGS at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	10	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	56		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	69	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	14	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	8.8	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	88	W	
Peak Diode Recovery dV/dt <sup>c</sup>	dV/dt	5.5	V/ns			
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	***	
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>	°C	
Mauring Tayous	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N · m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 528 \,\mu\text{H}$ ,  $R_g = 25 \,\Omega$ ,  $I_{AS} = 14 \,\text{A}$  (see fig. 12).
- c.  $I_{SD} \leq 14$  A,  $dI/dt \leq 140$  A/µs,  $V_{DD} \leq V_{DS},\, T_J \leq 175$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62			
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.7			

PARAMETER	SYMBOL	TEST (	MIN.	TYP.	MAX.	UNIT	
Static						•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = 250 μA	100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 1 mA	-	0.12	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	' <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>G</sub>	<sub>SS</sub> = ± 20 V	-	-	± 100	nA
Zoro Cata Valtago Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	-	25	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 80 V, V	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C		-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 8.4 A <sup>b</sup>	-	-	0.16	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 5	60 V, I <sub>D</sub> = 8.4 A <sup>b</sup>	5.1	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	670	-	
Output Capacitance	$C_{oss}$	Vı	<sub>DS</sub> = 25 V,	-	250	-	рF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	60	-	
Total Gate Charge	$Q_g$			-	=	26	
Gate-Source Charge	$Q_{gs}$	$V_{GS} = 10 \text{ V}$ $I_D = 14 \text{ A}, V_{DS} = 80 \text{ V},$	-	-	5.5	nC	
Gate-Drain Charge	Q <sub>gd</sub>		see fig. 6 and 13 <sup>b</sup>	-	-	11	1
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 50 \text{ V, } I_D = 14 \text{ A}$ $R_g = 12 \ \Omega, \ R_D = 3.6 \ \Omega, \ \text{see fig. } 10^b$		-	10	-	ns
Rise Time	t <sub>r</sub>			-	34	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	23	-	
Fall Time	t <sub>f</sub>			-	24	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from	-	4.5	-	-11	
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s	1					
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	_
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	56	- A
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 14 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T. = 25 °C 1	14 A dl/dt = 100 A/vah	-	150	280	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	$T_J = 25  ^{\circ}\text{C}, I_F = 14  \text{A, dI/dt} = 100  \text{A/}\mu\text{s}^b$		-	0.85	1.7	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-	on is do	minated b	ov Le and	L <sub>D</sub> )	

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

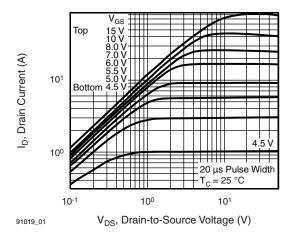


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

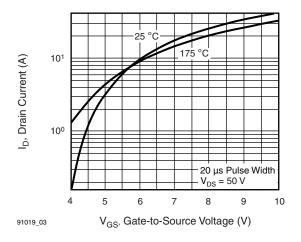


Fig. 3 - Typical Transfer Characteristics

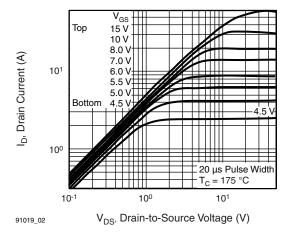


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

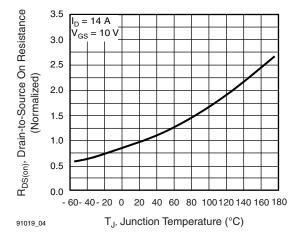
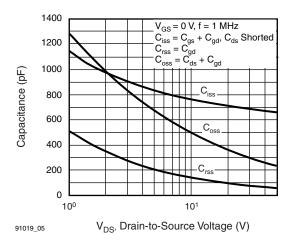
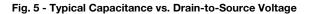


Fig. 4 - Normalized On-Resistance vs. Temperature







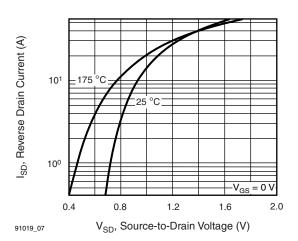


Fig. 7 - Typical Source-Drain Diode Forward Voltage

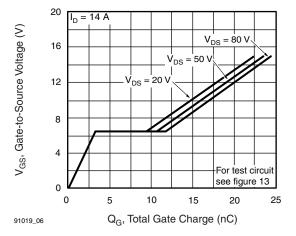


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

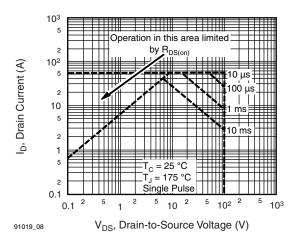


Fig. 8 - Maximum Safe Operating Area





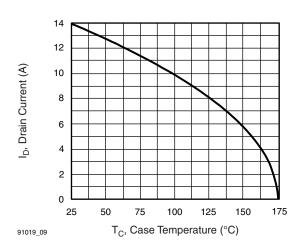


Fig. 9 - Maximum Drain Current vs. Case Temperature

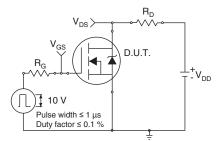


Fig. 10a - Switching Time Test Circuit

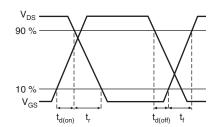


Fig. 10b - Switching Time Waveforms

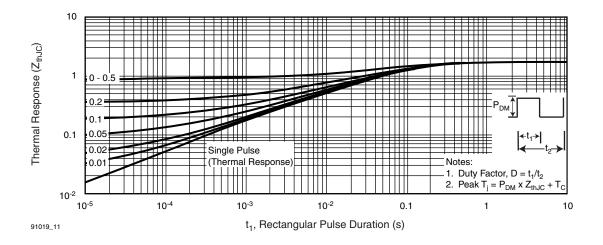


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



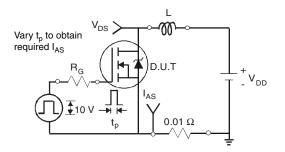


Fig. 12a - Unclamped Inductive Test Circuit

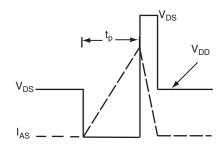


Fig. 12b - Unclamped Inductive Waveforms

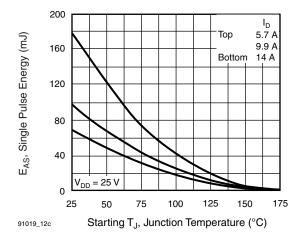


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

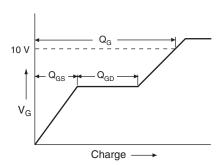


Fig. 13a - Basic Gate Charge Waveform

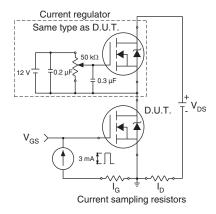
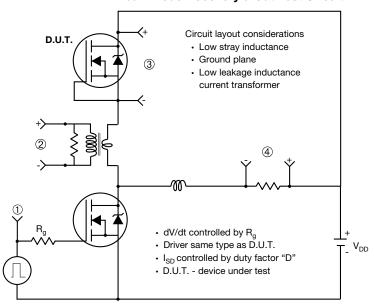


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



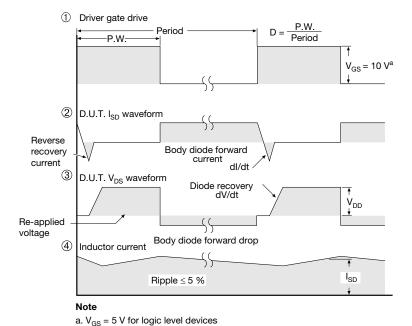


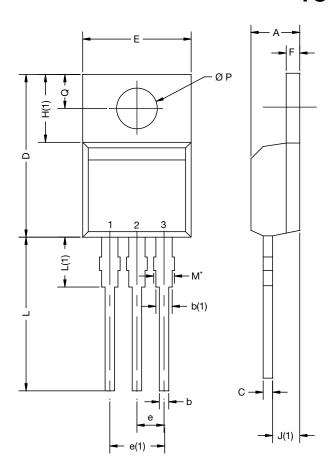
Fig. 14 - For N-Channel

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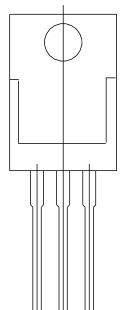
## TO-220-1



	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.14	4.70	0.163	0.185	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.73	0.045	0.068	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	0.43	1.40	0.017	0.055	
H(1)	6.10	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.59	3.00	0.102	0.118	
ECN: X15-0003-Rev. A, 19-Jan-15 DWG: 6031					

#### Notes

- M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM
- Outline conforms to JEDEC<sup>®</sup> outline TO-220AB with exception of dimension F



Revison: 19-Jan-15 1 Document Number: 66542



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Vishay

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Revision: 02-Oct-12 Document Number: 91000

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DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384

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